Application No. 10/046,781 Amdt. dated January 12, 2004 Reply to Office Action of September 15, 2003 Docket No. 8007-1003

## AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

## LISTING OF CLAIMS:

- 1-2. (cancelled)
- 3. (new) A tin-silver soldering alloy comprising 3 to 4% by weight of silver, 7.5% to 10% by weight of bismuth, and 0.1 to 1.5% by weight of zinc, with the balance essentially tin.
- 4. (new) A tin-silver soldering alloy comprising 3 to 4% by weight of silver, 5 to 10% by weight of bismuth, an effective amount of indium not more than 5% by weight, said amount being effective to increase the joint strength over 1,000 hours at 100°C, and 0.1 to 1.5% by weight of zinc, with the balance essentially tin.